

DOCKET NO.: SJ09-2000-0135

As a below named inventor, I hereby declare that:

'My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

claimed and for which a patent	is sought on the	invention entitled:		
INTEGRATED LEAD SUSPENSION FOR	R HIGH DENSITY DRI	VE		
the specification of which (ch	neck one)	•		
is attached hereto. X was filed on 09/28/2000 as Application Serial No. and was amended on		(if applicable).	•	
I hereby state that I have revincluding the claims, as amend			identified specification,	
I acknowledge the duty to disc 37, Code of Federal Regulation		which is material to patentabi	lity as defined in Title	
I hereby claim foreign priorit Section 365(b) of any foreign of any PCT International appli States, listed below and have certificate or PCT Internation which priority is claimed:	application(s) for cation which designated be	r patent or inventor's certifi gnated at least one country ot elow any foreign application f	icate, or Section 365(a) ther than the United for patent or inventor's	
Prior Foreign Application(s)		Pri	iority Claimed	
(Number)	(Country)	(Day/Month/Year Filed)	YesNo	
I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) or Section 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56, which occurred between the filing date of the prior application and the national or PCT international filing date of this application:				
(Application Serial No.)	(Filing Date)	(Status) (patented, pendir	ng. abandoned)	

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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